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| EXAM INIT | | | DOCUMENT NO. | DATE | NAME | CLASS | SUB CLASS | | ING ATE |
| N | PR | AA | 5,055,138 | 10/8/91 | Slinn | | | | |
| | | AB | 5,120,370 | 6/9/92 | Mori et al. | | | | _ |
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| NH | D | AF | 5,896,875 | 4/27/99 | Yoneda | _ | | | |
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| NH. | Ď. | AG | 0 548 596 A2 | 6/30/93 | EP | | | | |
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Information Disclosure Statement – Section 9 PTO-1449

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LIST OF PATENTS AND OTHER ITEMS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT APR 2 4 2000

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Bergman, Eric J. et al.

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| | AD | 5,308,745 | 5/3/94 | Schwartzkopf | | 0.0 | -F |
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| | AI | 5,705,089 | 1/6/98 | Sugihara et al. | | ROOM | ! |
| | AJ | 5,244,000 | 9/14/93 | Stanford et al. | | | |
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| NHQ | AM | 4,974,530 | 12/4/90 | Lyon | | | |

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| THE | AN | 0 548 596 A2 | 6/3/93 | Europe | | | | |
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| NO | AQ | GB 2 287 827 | 9/27/95 | United Kingdom | | | | |

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| DWZ | AS | Abstract of Japanese Appln. No. 52-100473 published March 14, 1979. | | |

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Information Disclosure Statement – Section 9 PTO-1449

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Bergman, Eric J. et al.

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| | AV | Abstract of Japanese Appln. No. 03-041729 published February 22, 1991 Abstract of Japanese Appln. No. 01-008630 published January 12, 1989 |
| | AX | Abstract of Japanese Appln. No. 03-041/29 published February 22, 1991 Abstract of Japanese Appln. No. 01-008630 published January 12, 1989 |
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Information Disclosure Statement - Section 9 PTO-1449

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Information Disclosure Statement - Section 9 PTO-1449

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APPLICANT:

Bergman, Eric J. et al.

FILING DATE: April 16, 1998 GROUP: 1746

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| EXAMINER INITIAL | | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE | |
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| | AC | 5,971,368 | 10/26/99 | Nelson et al. | | | | |
| THE | AD | 5,234,540 | 8/10/93 | Grant et al. | | | | |

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| The | AE | JP52-12063 | 4/4/97 | Japan | | | х | | |
| · NA | AF | JP 8 160032 | 1996 | Japan | | | x | | |

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| ALS | AF | Abstract of Japanese Appln. No. 3041729 published February 22, 1991 | 700 CF | <i>\$</i> ° |
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